June 1996



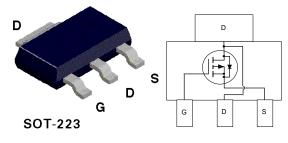
# NDT452AP P-Channel Enhancement Mode Field Effect Transistor

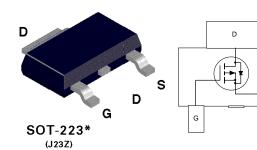
#### **General Description**

Power SOT P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and DC motor control.

#### Features

- -5A, -30V.  $R_{DS(ON)} = 0.065\Omega @ V_{GS} = -10V$  $R_{DS(ON)} = 0.1\Omega @ V_{GS} = -4.5V.$
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.





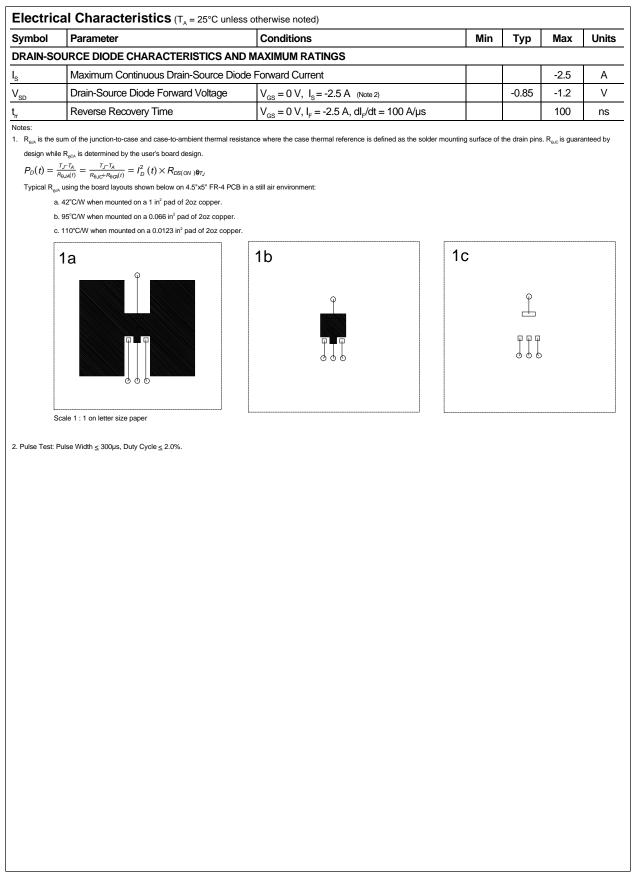
## **Absolute Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise noted

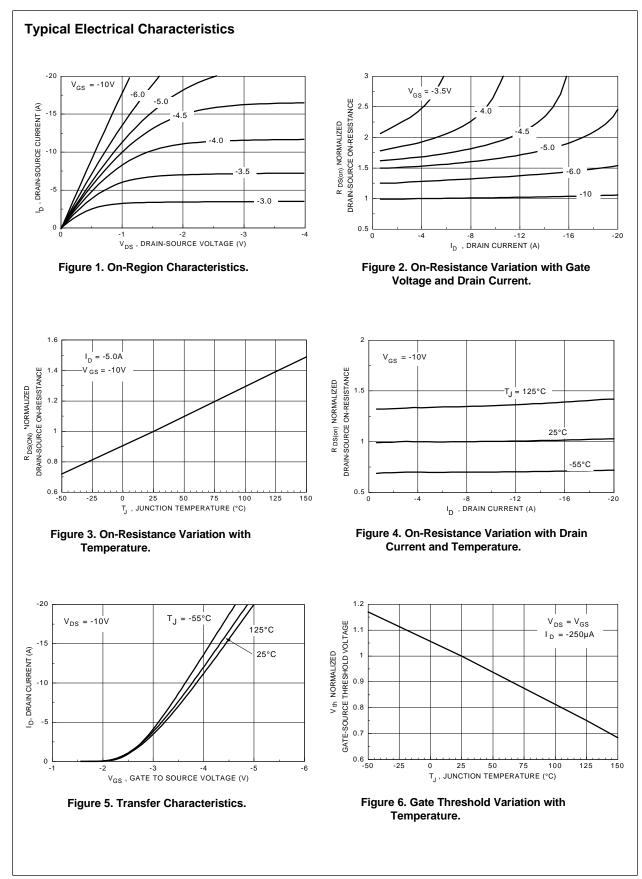
Symbol	Parameter		NDT452AP	Units
V <sub>DSS</sub>	Drain-Source Voltage		-30	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
l <sub>D</sub>	Drain Current - Continuous	(Note 1a)	-5	А
	- Pulsed		- 15	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	3	W
		(Note 1b)	1.3	
		(Note 1c)	1.1	
T_,T <sub>stg</sub>	Operating and Storage Temperature Range	e	-65 to 150	°C
THERMA	L CHARACTERISTICS			
R <sub>ÐJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	42	°C/W
R <sub>ØJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	12	°C/W
	tion J23Z for cropped center drain lead.			

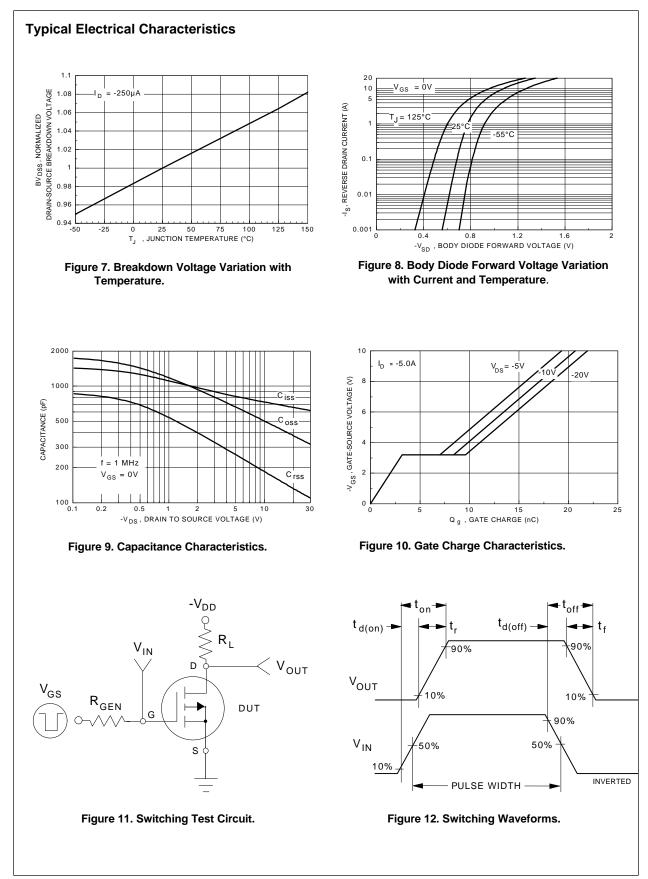
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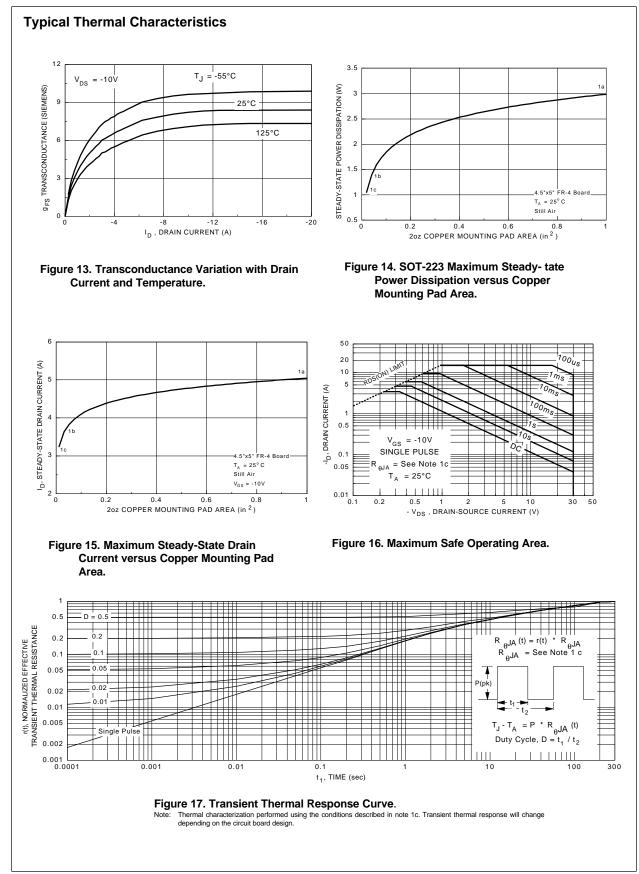
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS			•			
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			T <sub>J</sub> = 55°C			-10	μA
	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu A$		-1	-1.6	-2.8	V
			T <sub>J</sub> = 125°C	-0.7	-1.2	-2.2	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \ \text{I}_{D} = -5.0 \text{ A}$			0.052	0.065	Ω
			T <sub>J</sub> = 125°C		0.075	0.13	
		$V_{GS} = -4.5 \text{ V}, \ I_{D} = -4.3 \text{ A}$			0.085	0.1	
D(on)	On-State Drain Current	$V_{GS} = -10 \text{ V}, \text{ V}_{DS} = -5 \text{ V}$		-15			Α
		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-5			
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -10 \text{ V}, I_{D} = -5.0 \text{ A}$			7		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -15 V, V_{GS} = 0 V,$			690		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz			430		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				160		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = -10 V, I_{D} = -1 A,$			9	20	ns
t,	Turn - On Rise Time	$V_{\text{GEN}}$ = -10 V, $R_{\text{GEN}}$ = 6 $\Omega$			20	30	ns
D(off)	Turn - Off Delay Time				40	50	ns
t <sub>f</sub>	Turn - Off Fall Time				19	40	ns
Q	Total Gate Charge	V <sub>DS</sub> = -10 V,			22	30	nC
Q <sub>gs</sub>	Gate-Source Charge	$I_{\rm D} = -5.0 \text{ A}, V_{\rm GS} = -10 \text{ V}$			3.2		nC
Q <sub>gd</sub>	Gate-Drain Charge				5.2		nC









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